

NOT RECOMMENDED FOR NEW DESIGN **CONTACT US**



DMT6009LJ3

60V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D T _C = +25°C
60V	10mΩ @ V _{GS} = 10V	74.5A
	12.8m Ω @ V _{GS} = 4.5V	65.8A

Description and Applications

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

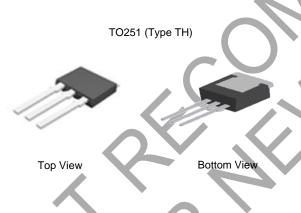
- Power management functions
- DC-DC converters
- Backlighting

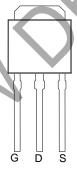
Features and Benefits

- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Low RDS(ON)—Ensures On State Losses Are Minimized
- Excellent Qgd x RDS(ON) Product (FOM)
- Advanced Technology for DC-DC Converters
- Small Form Factor Thermally Efficient Package Enables Higher **Density End Products**
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

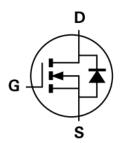
Mechanical Data

- Package: TO251
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.33 grams (Approximate)









Internal Schematic

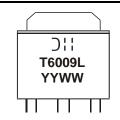
Ordering Information (Note 4)

Part Number		Package	Packing		
Part Number		Fackage	Qty.	Carrier	
DMT6009LJ3		TO251 (Type TH)	75 Pieces	Tube	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3).compliant. All applicable RoHS exemptions applied. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



T6009L = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 22 = 2022) WW or WW = Week Code (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	VDSS	60	V	
Gate-Source Voltage	Vgss	±16	V	
Continuous Drain Current (Note 7)	$T_C = +25$ °C $T_C = +70$ °C	I _D	74.5 59.6	Α
Maximum Body Diode Forward Current (Note 7)	Is	50	А	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	280	А	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)	I _{SM}	280	А	
Avalanche Current, L=0.1mH	IAS	28.2	А	
Avalanche Energy, L=0.1mH	Eas	39.8	mJ	

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 6)	T _A = +25°C	Pp	2.9	W
Thermal Resistance, Junction to Ambient (Note 6)		Reja	43	°C/W
Thermal Resistance, Junction to Ambient (Note 5)		ReJA	80	°C/W
Total Power Dissipation (Note 7)	$T_C = +25^{\circ}C$	P _D	83.3	W
Thermal Resistance, Junction to Case (Note 7)		Rejc	1.5	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BVDSS	60	_		V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}	1	1-	1	μΑ	V _{DS} = 48V, V _{GS} = 0V	
Gate-Source Leakage	Igss	_	1	±100	nA	Vgs = ±16V, Vps = 0V	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	0.7		2	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	Process	-	8	10	mΩ	V _{GS} = 10V, I _D = 13.5A	
Static Drain-Source On-Resistance	Rds(on)		9.8	12.8	11122	V _{GS} = 4.5V, I _D = 11.5A	
Diode Forward Voltage	VsD		0.8	1.2	V	$V_{GS} = 0V$, $I_{S} = 5A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss		1925			V _{DS} = 30V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss	_	438		pF		
Reverse Transfer Capacitance	Crss	_	41				
Gate Resistance	Rg	_	1.7	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	15.6	_			
Total Gate Charge (Vgs = 10V)	Qg	_	33.5	_	nC	V _{DS} = 30V, I _D = 13.5A	
Gate-Source Charge	Qgs	_	4.7		110		
Gate-Drain Charge	Q _{gd}	_	5.3	_			
Turn-On Delay Time	t _D (ON)	_	4.5	_			
Turn-On Rise Time	t _R	_	8.6	_		$V_{DD} = 30V, V_{GS} = 10V,$ $R_g = 6\Omega, I_D = 13.5A$	
Turn-Off Delay Time	tD(OFF)	_	35.9	_	ns		
Turn-Off Fall Time	t _F		15.7				
Body Diode Reverse Recovery Time	trr		18.2		ns	10.50 11/11 1000/	
Body Diode Reverse Recovery Charge	Q _{RR}	_	33.1	_	nC	$I_F = 13.5A$, $di/dt = 400A/\mu s$	

Notes:

5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.
7. Thermal resistance from junction to soldering point (on the exposed drain pad).
8. Short duration pulse test used to minimize self-heating effect.
9. Guaranteed by design. Not subject to production testing.

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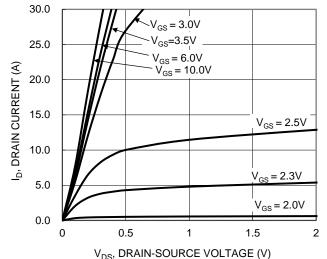


Figure 1. Typical Output Characteristic

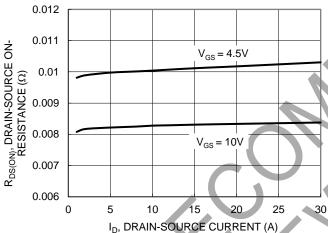


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

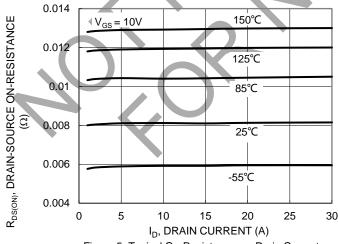
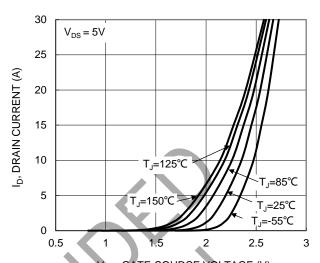


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature



V_{GS}, GATE-SOURCE VOLTAGE (V) Figure 2. Typical Transfer Characteristic

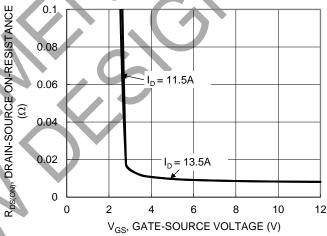
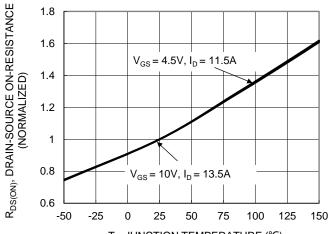


Figure 4. Typical Transfer Characteristic



 T_J , JUNCTION TEMPERATURE (°C) Figure 6. On-Resistance Variation with Junction Temperature





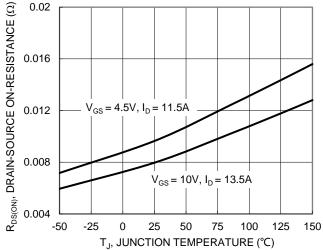


Figure 7. On-Resistance Variation with Junction Temperature

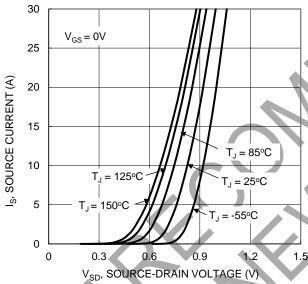
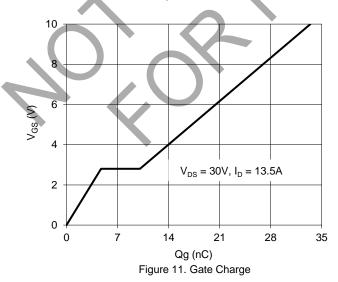


Figure 9. Diode Forward Voltage vs. Current



2.4 $V_{GS(TH)}$, GATE THRESHOLD VOLTAGE (V) 2.2 2 1.8 $I_D = 1mA$ 1.6 1.4 1.2 $I_{D} = 250 \mu A$ 1 8.0 0.6 0.4 0.2 50 75 100 125 -50 150 T_J , JUNCTION TEMPERATURE (°C)

Figure 8. Gate Threshold Variation vs. Junction Temperature

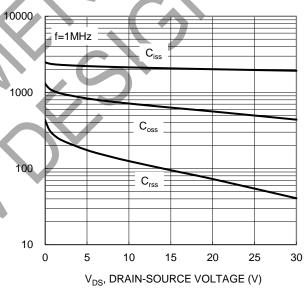
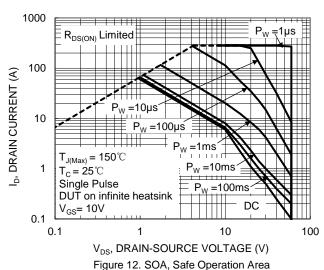
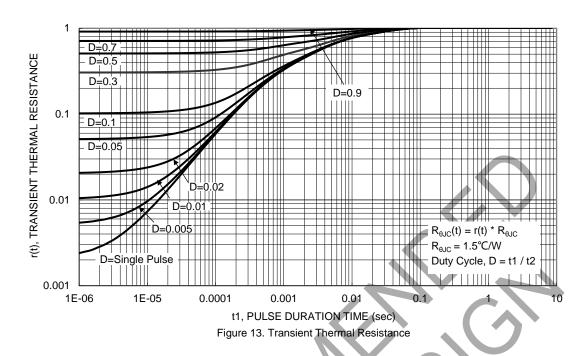


Figure 10. Typical Junction Capacitance



JUNCTION CAPACITANCE (PF

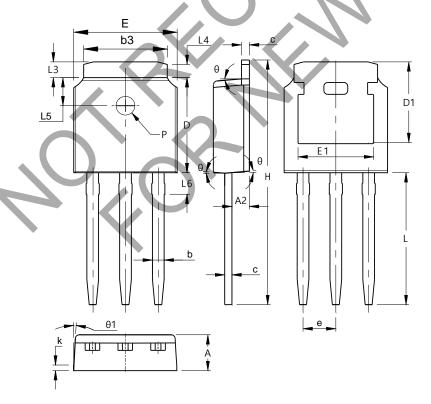




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

TO251 (Type TH)



TO251 (Type TH)					
Dim	Min	Max	Тур		
Α	2.20	2.40	2.30		
A2	0.97	1.17	1.07		
b	0.68	0.90	0.78		
b3	5.20	5.50	5.33		
С	0.43	0.63	0.53		
D	5.98	6.22	6.10		
D1	5	.30 RE	F		
е	2.	286 BS	C		
Е	6.40	6.80	6.60		
E1	4.63	5.03	4.83		
Н	16.22	16.82	16.52		
k	C	.40REI	F		
L	9.15	9.65	9.40		
L3	0.88	1.28	1.02		
L4	0	.75 RE	F		
L5	1.65	1.95	1.80		
L6	0.85	1.25	1.05		
ΡØ	1.20				
θ	5°	9°	7°		
θ1	5°	9°	7°		
All Dimensions in mm					



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